

IN THE CLAIMS:

Please amend Claims 21, 28-32 and 34, cancel Claims 22, 27, and 37-54 and add Claim 55 as follows:

1.-20. (Cancelled)

21. (Currently Amended) A photoelectric conversion device comprising:
a conductive member,

a plurality of substrates each having a plurality of photoelectric conversion elements, the plurality of substrates being arranged adjacent ~~each other~~ in a plane, and
a wavelength converting member disposed between the photoelectric conversion elements and the [[a]] conductive member, stacked and arranged on the photoelectric conversion elements over the plurality of substrates wherein said conductive member is grounded.

22. (Cancelled)

23. (Currently Amended) The photoelectric conversion device according to Claim ~~22~~ 21, wherein the wavelength converting member comprises a fluorescent member.

24. (Previously Presented) The photoelectric conversion device according to Claim 21, wherein the conductive member comprises an insulating base and a conductive layer provided thereon.

25. (Previously Presented) The photoelectric conversion device according to Claim 21, wherein the conductive member comprises a metal.

26. (Previously Presented) The photoelectric conversion device according to Claim 25, wherein the metal comprises aluminum.

27. (Cancelled)

28. (Currently Amended) The photoelectric conversion device according to Claim 21, wherein an area ~~for the provision of the photoelectric conversion elements is smaller than an area for the provision of the conductive member~~ overlaps said photoelectric conversion elements.

29. (Currently Amended) The photoelectric conversion device according to Claim 21, wherein ~~the~~ a periphery of the conductive member is sealed.

30. (Currently Amended) The photoelectric conversion device according to Claim 21, wherein ~~the~~ a periphery of the conductive member extends over the outer edges ~~periphery of the substrate~~ plurality of substrates and an edge portion ~~thereof~~ of said conductive member is sealed so as to cover the ~~substrate~~ outer edges of the plurality of substrates.

31. (Currently Amended) The photoelectric conversion device according to Claim 30, wherein a space is formed between the ~~periphery of the substrate~~ outer edges of said plurality of substrates and the conductive member.

32. (Currently Amended) The photoelectric conversion device according to Claim 30, wherein ~~an end face of the substrate~~ said outer edges of said plurality of substrates and the conductive member are in close contact with each other.

33. (Previously Presented) The photoelectric conversion device according to Claim 31, wherein a resin is provided in the space.

34. (Currently Amended) The photoelectric conversion device according to Claim 21, wherein a resin is provided which covers ~~the substrate~~ said plurality of substrates and all the end faces of the conductive member.

35. (Previously Presented) The photoelectric conversion device according to Claim 21, wherein the plurality of photoelectric conversion elements are arranged in a matrix.

36. (Previously Presented) The photoelectric conversion device according to Claim 26, wherein the metal has a thickness of 100 μm or less.

37. - 54. (Cancelled)

55. (New) An imaging apparatus comprising, the photoelectric conversion device according to claim 21, a control circuit for driving the device and an apparatus body including said photoelectric device and said control circuit.